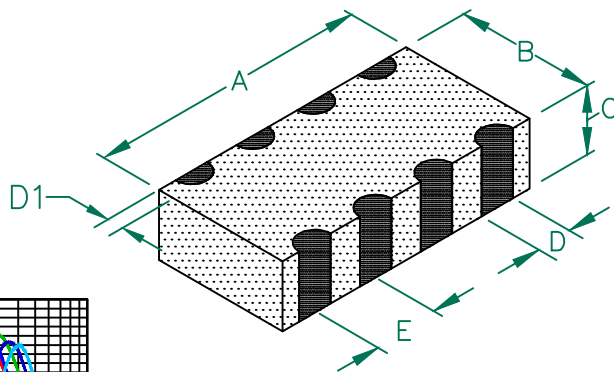


DA1206B601R-10

PHYSICAL DIMENSIONS:

A	3.20 [.126]	+ 0.20 [.008]
B	1.60 [.063]	+ 0.20 [.008]
C	0.80 [.031]	+ 0.20 [.008]
D	0.40 [.016]	+ 0.15 [.006]
D1	0.30 [.012]	+ 0.20 [.008]
E	0.80 [.031]	+ 0.10 [.004]



ELECTRICAL CHARACTERISTICS:

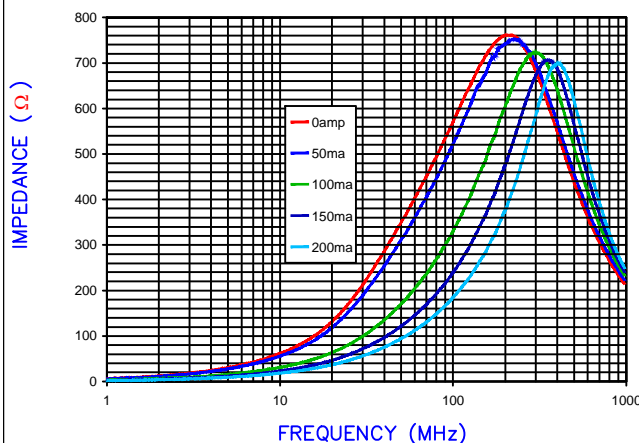
Z @ 100MHz (Ω)	DCR (Ω)	Rated Current
Nominal	600	
Minimum	450	
Maximum	750	200 mA

LINE TO LINE INSULATION RESISTANCE
>100 M Ω AT 75 VOLTS.

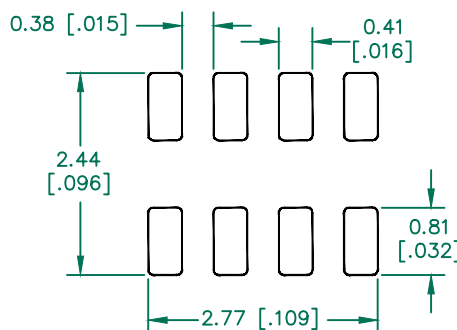
NOTES: UNLESS OTHERWISE SPECIFIED

1. TAPED AND REELED per CURRENT EIA SPECIFICATIONS 7" REELS, 3000 PCS/REEL EMBOSSED PLASTIC TAPE.
2. TERMINATION FINISH IS 100% TIN.
3. COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
4. OPERATING TEMPERATURE TEMP: -40°C~+125°C (INCLUDING SELF-HEATING)
5. COSMETIC SPECIFICATION REFER TO WI-QA-124.

Z vs FREQUENCY
IMPEDANCE UNDER DC BIAS

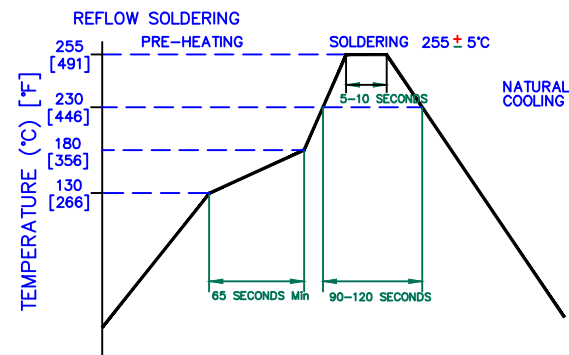


LAND PATTERNS FOR REFLOW SOLDERING

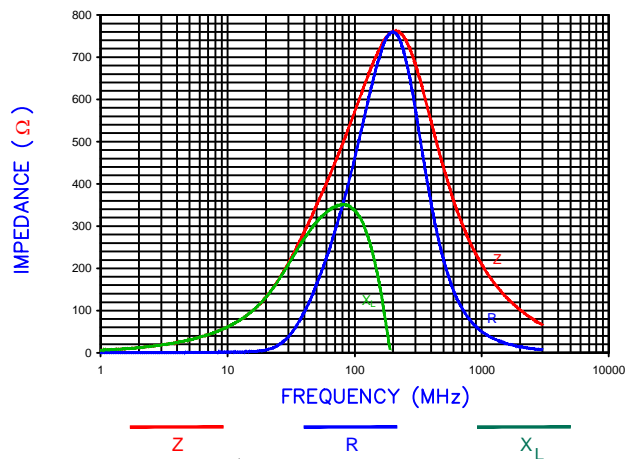


(For wave soldering, add 0.762 (0.030) to this dimension)

RECOMMENDED SOLDERING CONDITIONS



|Z|, R, AND X vs. FREQUENCY



AGILENT E4991A RF Impedance/Material Analyzer
HP 16194A Test Fixture. TEST REF. 3236

RoHS

DIMENSIONS ARE IN mm [INCHES].

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E	OPERATING TEMPERATURE UPDATE LAIRD LOGO AND REFLOW CURVE	08/05/13	QU			PROJECT/PART NUMBER: DA1206B601R-10	
D	UPDATE COMPANY LOGO	05/20/09	JRK	REV	E	PART TYPE: CO-FIRE	DRAWN BY: TMB
C	D1 dim chgd from 0.008 ±0.004 to 0.012 ± 0.008. UPDATE COMPANY LOGO	10/30/07	JRK	DATE:	03/30/04	SCALE: NTS	SHEET: -
B	CHANGE DCR, MODIFY NOTE 1 ADD ROHS	11/30/06	JRK	CAD #	DA1206B601R-10-E	TOOL #	-
A	ORIGINAL DRAFT	03/30/04	TMB				1 of 1
REV	DESCRIPTION	DATE	INT				